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Forthright scrutiny of the VCSEL business: opportunities & obstacles

> Mark Lutkowitz, Principal EPIC Meeting in Stuttgart, Germany October 17, 2019

Overview: Inverted Pyramid Presentation



Future of main VCSEL market sectors Competitive landscape Focus on datacom Smartphone/Consumer outlook Auto, LiDAR, avionics apps

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Major VCSEL Applications & Growth Perspectives



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High-Power 940nm VCSEL Outlook



- Lots of competitors chasing these devices
 > Building new fabs
 - > Demand hasn't emerged as quickly as anticipated
 - -- Apple remains primary user & too many focused on this one segment to detriment of others
 - -- Tough situation in sitting on large, idle capacity (needs customer like Apple to drive volumes)
- 940nm will progressively be bigger market with some growth possible as early as 2020
 > Principal unknown is Apple's drawing board (ex. robots)

Smartphone VCSEL Market Specifically



- No quantum leap expected in short term
 - > Volumes not much higher in 2019 compared with '18 and '17
 - > Androids increasingly filling in, face-ID side first
 - > No step-wise increase expected with worldfacing, yet
 - -- Impacting a few Android phones with tendency to place in models only 5% of volume
 - -- Apple could introduce killer app/part
 - > Best case scenario is doubling of VCSEL revenues

Datacom VCSEL Growth



- Niche continues growth at historical clip
 - > Roughly 10%/year (margins on chips probably much better than 940nm)

-- Datacom is old-faithful, but not sexy market anymore

- 2 areas needing near-term breakthroughs
 - > 50-gig PAM4 technology still a year from that nut being completely cracked (for 100G MMF)
 - > Still some rollout issues with 25-gig & VCSELs
 - -- Some giveback on high-temperature operation

Autonomous Driving VCESEL Opportunities



- Most attractive aspect is confluence of about 50 different sensors slowly playing out
 - > VCSELs will be about a half dozen of them
 - -- Could be next big distribution channel after smartphones
 - -- Available now for gesturing in-cabin/driver awareness, etc.
 - -- \$300K/year Mercedes first/in 20 years, down to Yugos
 - -- VCSEL availability on outside of car looking out could take at least as long as another 3 years

Another Impact of Autos on VCSELs



- Each car will be generating probably over 100 gigabytes of data every day
 - > Has to go somewhere
 - -- Cannot remain in car for long
 - > May not be vision compression with cameras
 - -- Can have some anomalies for such critical functions
 - > Data storage space will be beneficiary
 - -- Corollary market of growth for VCSELs





- LiDAR space very fragmented right now
 - > Sources of all types and all wavelengths
 - > While people talk about high-powered VCSELs
 - -- Problem really is LiDAR needs a bigger throw and so there is uncertainty
- LiDAR is also quite costly
- Perhaps little hope for meaningful sales of VCSELs outside the car

Lots of Smaller, Specialized VCSEL Apps in Military, Aerospace, etc.



- In aggregate, about a third of datacom VCSEL space, which won't really drive volume
 - > Adds diversity/packaging opportunities
 - > Interesting for smaller, niche companies, which didn't spend \$100M on a fab, to produce VCSELs with unique performance (ex. oxygen sensors)

-- Talking about as low as \$1M/year opportunity

- > Variety of new products will be coming out in the 3D-recognition world
 - -- Catering to hobbyists (VCSELs going on drones, etc.)

Competitive Analysis of Major VCSEL Vendors



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Lumentum's Dominant Smartphone VCSEL Position



- Foundry business model saved it from making early mistakes
- Potential long-term problems
 - > No ownership of vertical integration
 - > Apple prefers domestic supplier
 - -- IP protection & political benefits
 - > Price declines despite market position
 - > Limited Android growth
 - > Early loose lips on margin generation

WIN Semiconductors Showed Everybody Up at Start on 6" VCSELs



- Just had better fab/engineering expertise
 > Yields have improved considerably since that time
- Like other GaAs producers
 - > Cell phone power amps will produce margins
 - > Opening up markets to low-margin
 opportunities can be advantageous to ensure
 90%+ fab utilization
 - -- Ex. Avago with 0% margin on VCSELs in computer mouses in past (made money on datacom devices)

IQE Overbuilt Capacity



 Biggest problem for EPI company is like other players, constructed for a flood

> Instead got a light rain

- Apparent difficulty with continual messing with EPI stack
 - > Every time there is a little change
 - -- Run risk of technical issues

Major Changes at Finisar (now II-VI)

- fibeReality
- Lost bet on 6-inch VCSELs not happening
- fibeReality picked up some intelligence
 > Finisar stopped supporting datacom customers
 - > Lots of VCSEL talent left the company
 - -- Including arguably best designer in the world
 - -- Risks historic connection with Apple
- Sherman, TX plant intending only 940nm
 - > May easily be enough 3" VCSEL suppliers now
 - -- Wonder about adequate utilization at fab

A lot of Questions with II-VI & VCSELs



- II-VI still appears committed to datacom
 > Feedback from IBM/government work
 - -- But only just starting to look under Finisar hood
- Marketing stress on 940nm
 - > Dealing with too much production capacity
 - > Apple likely favors Sherman, TX fab succeeding
 - > Newton Aycliffe albatross
 - > Warren, NJ fab had been train wreck in past

-- Had a hard time making HBTs

VCSEL Chips: Big Money Maker for Broadcom



- Dominant player in datacom bare die space
 > Doing R&D work on 100G VCSELs
- Large supplier to Apple in general
 > Declined to enter 6" 3D-sensor space
 - -- Capable, but didn't see adequate profitability
- Industrial apps
 - > Separate from main optic chip biz
 - -- Industrial Fiber Product Division

Sumitomo VCSEL Biz Taken Out of Mothballs/Wild Card



- Several years ago bought Emcore assets
 > Shut down in Albuquerque & moved to Japan
- Head of auto cable harness biz: pro-VCSELs
- Very big sales to Huawei generally
- No interest in sensors for now
- Focus on only datacom VCSELs
 - > Threat is firms with idle capacity moving into space
 - -- Sumitomo can't keep up with 6" fabs

Other VCSEL Suppliers



- Skyworks in pretty good position from fab perspective with manufacturing expertise
- Limited number of high-quality, high reliability, high-speed (25-gig and above) datacom firms

> Like TRUMPF/Philips

- ams has advantage with Android customers
 > Offers full turnkey solution
- For BiDi, Cisco Systems sells 855nm & 910nm

Data Communications VCSEL Space





VCSEL Usage by Large Data Centers



- Alibaba uses a very large number of VCSELs
 - > In general, Chinese data centers tend to be constrained by space
 - > Alibaba wants SR4.2 (2 wavelengths/fiber)

-- Large enterprises everywhere expected to use this type

 Google is apparently only US hyperscaler, which has deployed a lot of VCSELs so far

> Including SR4 over OM3 fiber

> Shifting to 400G-SR8 (8 pair – 1 lambda/fiber)

Microsoft's Plan to Flatten Data Center Architectures



- Multimode fiber ideal for 30m & lower
 - > ½ of Microsoft's networking problems involve cleaning singlemode fiber connectors
 - > Other hyperscalers likely to adopt DC approach
 - > Yet, Microsoft networking leader against its use
 - -- Avoid managing 3 part numbers (SMF, copper, MMF)
 - -- Prefers 32-channel DWDM duplex solution
 - -- Otherwise, no particular prejudice against MMF itself
 - -- fibeReality believes Jeff Cox will change his mind

100G VCSELs Could Help Accelerate Elimination of Top-of-Rack Switches



- Appears technically feasible & cost-effective
 > 100G VCSEL demo at ECOC by Finisar
- Significant rise in bandwidth over other VCSEL solutions
- Choice of either 850nm or 940nm
- Being studied by IEEE 802.3
 - > Presentation by OFS
 - -- "Standardizing a ~30m (TBD) VCSEL PMD will prepare the way for 100m PMD in a future step"

Bottom Line for Hyperscaler VCSEL/MMF Market Size



- Fiber vendors don't like yields as much with MMF
- Copper still potential play in many cases
- On the pro side:
 - > Lower cost/lower power with MMF vs SMF TXs
 - > Alignment tolerances about 10x different between SM & MM
 - > Silicon photonics not a threat

-- Concept first mentioned 50 years ago this month

Final Frontier for Datacom VCSELs



- Last volume increase: shortest reach links
 - > Perhaps all backplane connections can be MMF on massive switch
 - -- With uniform electrical interface defined for CPO in very long-term
 - -- IBM renewing government project to develop VCSELbased CPO
 - > MMF made for HPC (work on 50G NRZ module)
 - -- if reliability issue solved
 - -- GPUs, accelerators, memory banks (evolution into 3 tiers vs 2 tiers), etc., all within few meters

More on Smartphones & Consumer Applications









Apple's Unique Situation to Achieve Uniform Process in '17



6" VCSEL Fabs



A lot of Early 6" Yields Were Lost



 Apple leaned kind of heavily on Finisar on 4" to fill initial phone orders

> Renegotiated contract just to make volumes

- Somebody made simple math miscalculation
 - > A lot more inventory in pipeline than originally thought
 - -- After initial rush
 - -- Really slowed down momentum

Smartphone Pricing and New VCSEL Developments



• Greater VCSEL price pressures

> Me-too processes insisted by Apple

- Possibly sensor needed for "jaw detection"
 - > Miniscule wafer volumes because they are tiny devices (200,000 on a wafer)

-- Would not materially affect fab costs

- Speculation about other side of the phone camera
- Possible needs for larger die/higher power

Larger Diameter VCSEL Wafers Unlikely to Happen Soon



- Assumption may go to 8" for consumer apps to get costs down further
 - > Pulling off 6-inch alone was minor miracle
 - > RFIC industry processes 20,000 to 40,000 6inch wafers/week
 - > Maybe VCSELs in its entire heyday, production was several hundred 6" wafers/week
 - -- Would be silly to try to lead from optics perspective
 - -- As aside, microLEDs are driving some 8" GaAs planning

Closer Look at Automotive & Avionics









Evaluation of Auto OEMs



- Audi is considered a leader in networks
- Ford is second

> Surprisingly advanced with Ethernet testing lab

- Toyota is one of the most conservative
- Common philosophy similar to satellite folks
 - > New technology will not be used unless tested for 10-20 years to avoid questions about reliability

-- A lot of disdain/concern even for Ethernet robustness (let alone copper & fiber considerations)

Specific Problems with LiDAR & Autonomous Driving



- Extremely long market cycles in automotive
 New IEEE project could easily go to '24/'25
- Possibility of primary computer dropping out/auto firms nervous about crashes
 - > Can't say "let's reboot"
 - > Need backup that knows everything
 - -- 2 redundant processors mirroring each other & huge bandwidth requirement between them

LiDAR Proponents Banking on Government Safety Standards



- Regulation process very slow
- Intelligent vehicle-highway-system in US
 - > Began in late '80s
 - > Chicago to Florida at 130/hour on guideway with all controls handled electronically
 - -- "The technology is here today," according to David Cole, director of the Office for the Study of Automotive Transportation at the University of Michigan, Chicago Tribune, March 19, 1989
 - -- Commitment to system by GM & federal gov't

More on Autonomous Driving



- InP-based radar systems probably not costeffective either
- All the technologies can be spoofed
 > Need to combine all solutions
 - -- Even more price pressure
- LiDAR startups may go way of solar firms
 > After burining much VC money spent

Avionics: Generally Higher Value VCSEL Apps



- Moving more optics on planes, so good opportunity for a small company
 - > Looking for very extreme temperature range operations, tremendous amount of ruggedness, & quite high reliability
 - -- Last thing you want to do is take panel off plane, go back into wing, etc.
 - -- Customers very willing to pay a few dollars more for something they know absolutely works



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